

# INTERNATIONAL STANDARD

# NORME INTERNATIONALE



**Field device integration (FDI®) –  
Part 1: Overview**

**Intégration des appareils de terrain (FDI®) –  
Partie 1: Vue d'ensemble**



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This third edition cancels and replaces the second edition published in 2021. This edition constitutes a technical revision.

This edition includes the following significant technical changes with respect to the previous edition:

- a) added references to Part 6-100 and Part 6-200 (technology mapping for .NET and HTML5);
- b) updated Subclause 8.3.1: major version, minor version and revision shall be written as two-digit numbers;
- c) added reference to new Part 8 and FDI® OPC UA Server Facet.

The text of this International Standard is based on the following documents:

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Full information on the voting for its approval can be found in the report on voting indicated in the above table.

The language used for the development of this International Standard is English.

This document was drafted in accordance with ISO/IEC Directives, Part 2, and developed in accordance with ISO/IEC Directives, Part 1 and ISO/IEC Directives, IEC Supplement, available at [www.iec.ch/members\\_experts/refdocs](http://www.iec.ch/members_experts/refdocs). The main document types developed by IEC are described in greater detail at [www.iec.ch/standardsdev/publications](http://www.iec.ch/standardsdev/publications).

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